

RADIATION HARDENED LOW POWER NPN SILICON TRANSISTOR

Qualified per MIL-PRF-19500/391

Qualified Levels:
JANSM, JANSJ,
JANSK, JANSL, and
JANSR

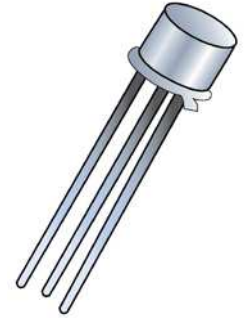
DESCRIPTION

This RHA level 2N3019 and 2N3019S NPN leaded metal device is RAD hard qualified for high-reliability applications. Microsemi also offers numerous other transistor products to meet higher and lower power ratings with various switching speed requirements in both through-hole and surface-mount packages.

Important: For the latest information, visit our website <http://www.microsemi.com>.

FEATURES

- JEDEC registered 2N3019.
- RHA level JAN qualifications per MIL-PRF-19500/391 (see [part nomenclature](#) for all options).




**TO-39 (TO-205AD)
and TO-5 Package**

Also available in:


TO-46 (TO-206AB)

(leaded)
 [JANS 2N3057A](#)

TO-18 (TO-206AA)

(leaded)
 [JANS 2N3700](#)

UB package

(leaded)
 [JANS 2N3700UB](#)

APPLICATIONS / BENEFITS

- Leaded TO-39 and TO-5 package.
- Lightweight.
- Low power.
- Military and other high-reliability applications.

MAXIMUM RATINGS @ $T_A = +25\text{ }^\circ\text{C}$ unless otherwise noted

| Parameters/Test Conditions | Symbol | Value | Unit |
|--|--|-------------|--------------------|
| Junction and Storage Temperature | T_J and T_{STG} | -65 to +200 | $^\circ\text{C}$ |
| Thermal Resistance Junction-to-Ambient | $R_{\theta JA}$ | 195 | $^\circ\text{C/W}$ |
| Thermal Resistance Junction-to-Case | $R_{\theta JC}$ | 30 | $^\circ\text{C/W}$ |
| Collector-Emitter Voltage | V_{CEO} | 80 | V |
| Collector-Base Voltage | V_{CBO} | 140 | V |
| Emitter-Base Voltage | V_{EBO} | 7.0 | V |
| Collector Current | I_C | 1.0 | A |
| Total Power Dissipation: | P_D | 0.8 | W |
| | @ $T_A = +25\text{ }^\circ\text{C}$ ⁽¹⁾ | | |
| | @ $T_C = +25\text{ }^\circ\text{C}$ ⁽²⁾ | 5.0 | |

- Notes:**
1. Derate linearly 4.6 mW/ $^\circ\text{C}$ for $T_A \geq +25\text{ }^\circ\text{C}$.
 2. Derate linearly 28.6 mW/ $^\circ\text{C}$ for $T_C \geq +25\text{ }^\circ\text{C}$.

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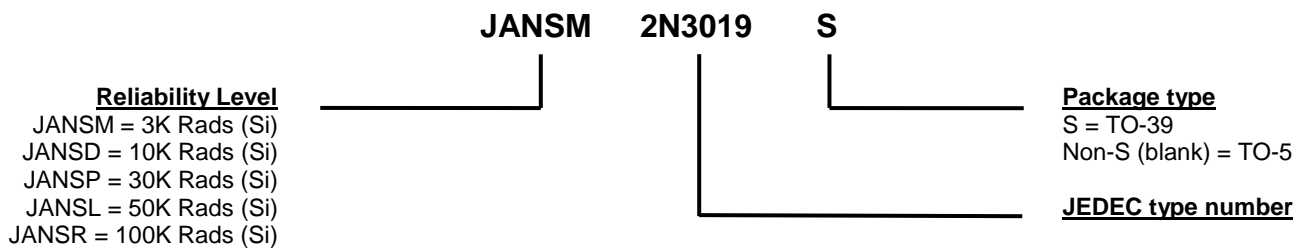
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MECHANICAL and PACKAGING

- CASE: Hermetically sealed, kovar base, nickel cap.
- TERMINALS: Gold plate, solder dip (Sn63/Pb37) available upon request.
- MARKING: Part number, date code, manufacturer's ID and serial number.
- POLARITY: NPN.
- WEIGHT: Approximately 1.064 grams.
- See [Package Dimensions](#) on last page.

PART NOMENCLATURE

SYMBOLS & DEFINITIONS

| Symbol | Definition |
|-----------------|-----------------------------------|
| f | frequency |
| I _B | Base current (dc) |
| I _E | Emitter current (dc) |
| T _A | Ambient temperature |
| T _C | Case temperature |
| V _{CB} | Collector to base voltage (dc) |
| V _{CE} | Collector to emitter voltage (dc) |
| V _{EB} | Emitter to base voltage (dc) |

ELECTRICAL CHARACTERISTICS @ $T_A = +25\text{ }^\circ\text{C}$, unless otherwise noted

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
|---|---------------|-----------------------------|--------------------------|----------------|
| OFF CHARACTERISTICS | | | | |
| Collector-Emitter Breakdown Current $I_C = 30\text{ mA}$ | $V_{(BR)CEO}$ | 80 | | V |
| Collector-Base Cutoff Current $V_{CB} = 140\text{ V}$ | I_{CBO} | | 10 | μA |
| Emitter-Base Cutoff Current $V_{EB} = 7\text{ V}$ | I_{EBO1} | | 10 | μA |
| Collector-Emitter Cutoff Current $V_{CE} = 90\text{ V}$ | I_{CES} | | 10 | ηA |
| Emitter-Base Cutoff Current $V_{EB} = 5.0\text{ V}$ | I_{EBO2} | | 10 | ηA |
| ON CHARACTERISTICS | | | | |
| Forward-Current Transfer Ratio $I_C = 150\text{ mA}, V_{CE} = 10\text{ V}$ $I_C = 0.1\text{ mA}, V_{CE} = 10\text{ V}$ $I_C = 10\text{ mA}, V_{CE} = 10\text{ V}$ $I_C = 500\text{ mA}, V_{CE} = 10\text{ V}$ $I_C = 1.0\text{ A}, V_{CE} = 10\text{ V}$ | h_{FE} | 100 50 90 50 15 | 300 300 300 300 | |
| Collector-Emitter Saturation Voltage $I_C = 150\text{ mA}, I_B = 15\text{ mA}$ $I_C = 500\text{ mA}, I_B = 50\text{ mA}$ | $V_{CE(sat)}$ | | 0.2 0.5 | V |
| Base-Emitter Saturation Voltage $I_C = 150\text{ mA}, I_B = 15\text{ mA}$ | $V_{BE(sat)}$ | | 1.1 | V |

DYNAMIC CHARACTERISTICS

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
|---|------------|------|------|------|
| Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 1.0\text{ mA}, V_{CE} = 5.0\text{ V}, f = 1.0\text{ kHz}$ | h_{fe} | 80 | 400 | |
| Magnitude of Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 50\text{ mA}, V_{CE} = 10\text{ V}, f = 20\text{ MHz}$ | $ h_{fe} $ | 5.0 | 20 | |
| Output Capacitance $V_{CB} = 10\text{ V}, I_E = 0, 100\text{ kHz} \leq f \leq 1.0\text{ MHz}$ | C_{obo} | | 12 | pF |
| Input Capacitance $V_{EB} = 0.5\text{ V}, I_C = 0, 100\text{ kHz} \leq f \leq 1.0\text{ MHz}$ | C_{ibo} | | 60 | pF |

ELECTRICAL CHARACTERISTICS @ $T_A = +25\text{ }^\circ\text{C}$, unless otherwise noted (continued)
SAFE OPERATION AREA (See SOA graph below and [MIL-STD-750, method 3053](#))

DC Tests
 $T_C = 25\text{ }^\circ\text{C}$, 1 cycle, $t = 10\text{ ms}$
Test 1

2N3019, 2N3019S

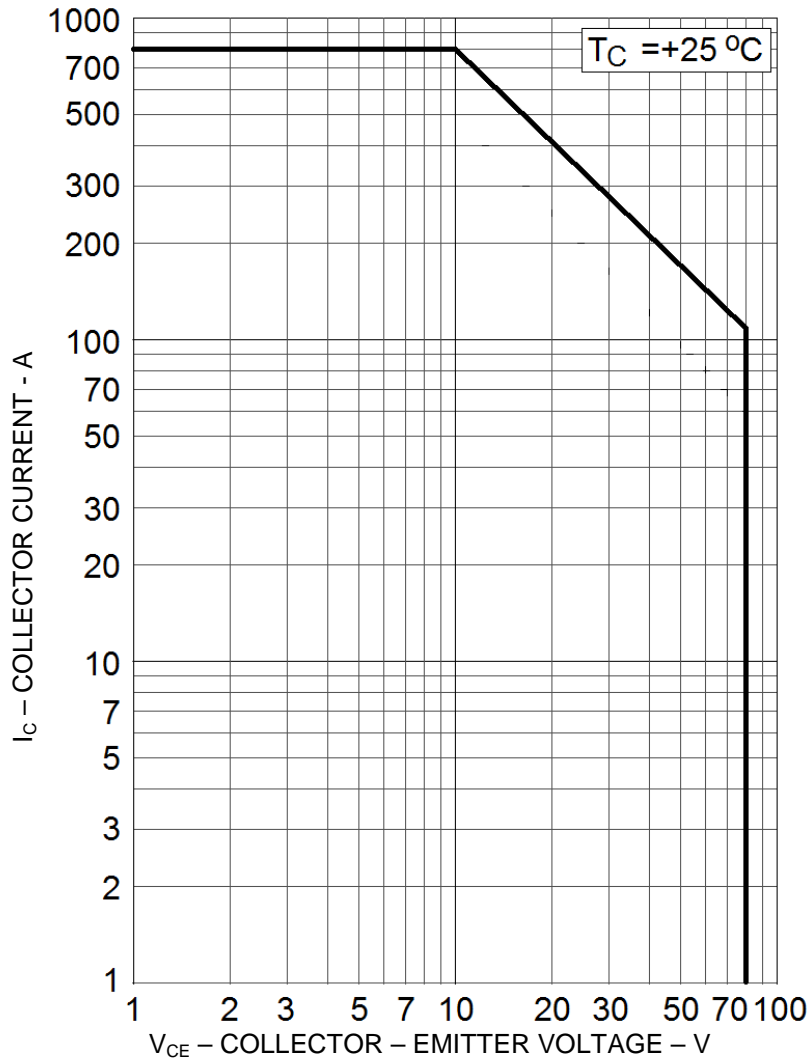
 $V_{CE} = 10\text{ V}$
 $I_C = 500\text{ mA}$
Test 2

2N3019, 2N3019S

 $V_{CE} = 40\text{ V}$
 $I_C = 125\text{ mA}$
Test 3

2N3019, 2N3019S

 $V_{CE} = 80\text{ V}$
 $I_C = 60\text{ mA}$

 (1) Pulse Test: Pulse Width = $300\text{ }\mu\text{s}$, duty cycle $\leq 2.0\%$

Maximum Safe Operating Area

ELECTRICAL CHARACTERISTICS @ $T_A = +25\text{ }^\circ\text{C}$, unless otherwise noted (continued)
POST RADIATION ELECTRICAL CHARACTERISTICS

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
|--|---------------|---------------------------------------|--------------------------|----------------|
| Collector to Base Cutoff Current $V_{CB} = 140\text{ V}$ | I_{CBO} | | 20 | μA |
| Emitter to Base Cutoff Current $V_{EB} = 7\text{ V}$ | I_{EBO} | | 20 | μA |
| Collector to Emitter Breakdown Voltage $I_C = 30\text{ mA}$ | $V_{(BR)CEO}$ | 80 | | V |
| Collector-Emitter Cutoff Current $V_{CE} = 90\text{ V}$ | I_{CES} | | 20 | ηA |
| Emitter-Base Cutoff Current $V_{EB} = 5.0\text{ V}$ | I_{EBO} | | 20 | ηA |
| Forward-Current Transfer Ratio ⁽²⁾ $I_C = 150\text{ mA}, V_{CE} = 10\text{ V}$ $I_C = 0.1\text{ mA}, V_{CE} = 10\text{ V}$ $I_C = 10\text{ mA}, V_{CE} = 10\text{ V}$ $I_C = 500\text{ mA}, V_{CE} = 10\text{ V}$ $I_C = 1\text{ A}, V_{CE} = 10\text{ V}$ | $[h_{FE}]$ | [50] [25] [45] [25] [7.5] | 300 300 300 300 | |
| Collector-Emitter Saturation Voltage $I_C = 150\text{ mA}, I_B = 15\text{ mA}$ $I_C = 500\text{ mA}, I_B = 50\text{ mA}$ | $V_{CE(sat)}$ | | 0.23 0.58 | V |
| Base-Emitter Saturation Voltage $I_C = 150\text{ mA}, I_B = 15\text{ mA}$ | $V_{BE(sat)}$ | | 1.27 | V |

- (2) See method 1019 of MIL-STD-750 for how to determine $[h_{FE}]$ by first calculating the delta ($1/h_{FE}$) from the pre- and post-radiation h_{FE} . Notice the $[h_{FE}]$ is not the same as h_{FE} and cannot be measured directly. The $[h_{FE}]$ value can never exceed the pre-radiation minimum h_{FE} that it is based upon.

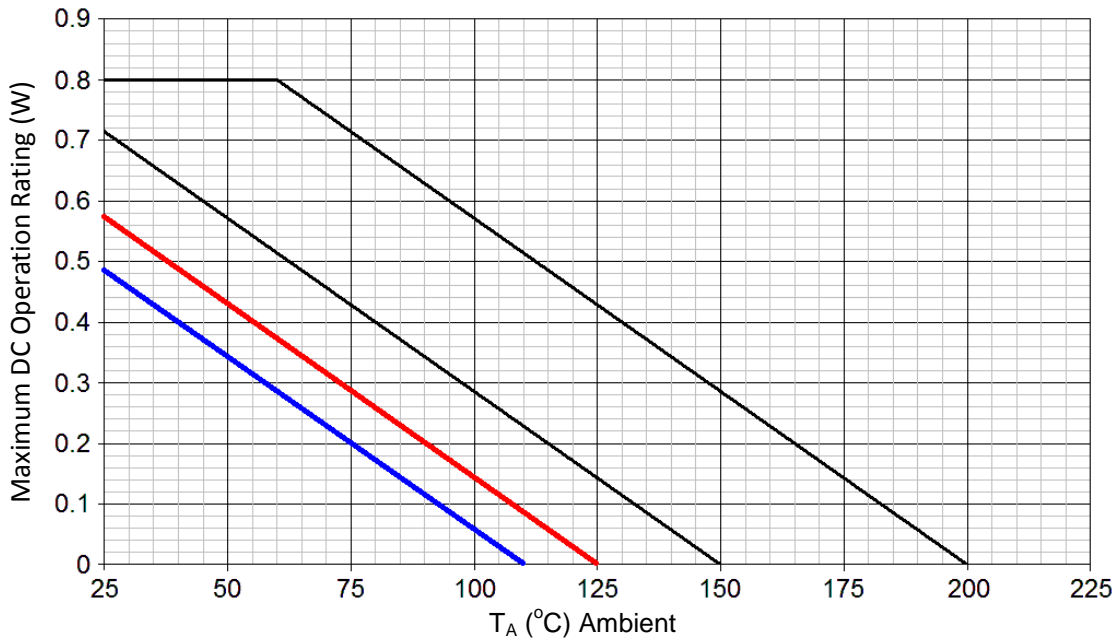
GRAPHS


FIGURE 1
Temperature - Power Derating ($R_{\theta JA}$)

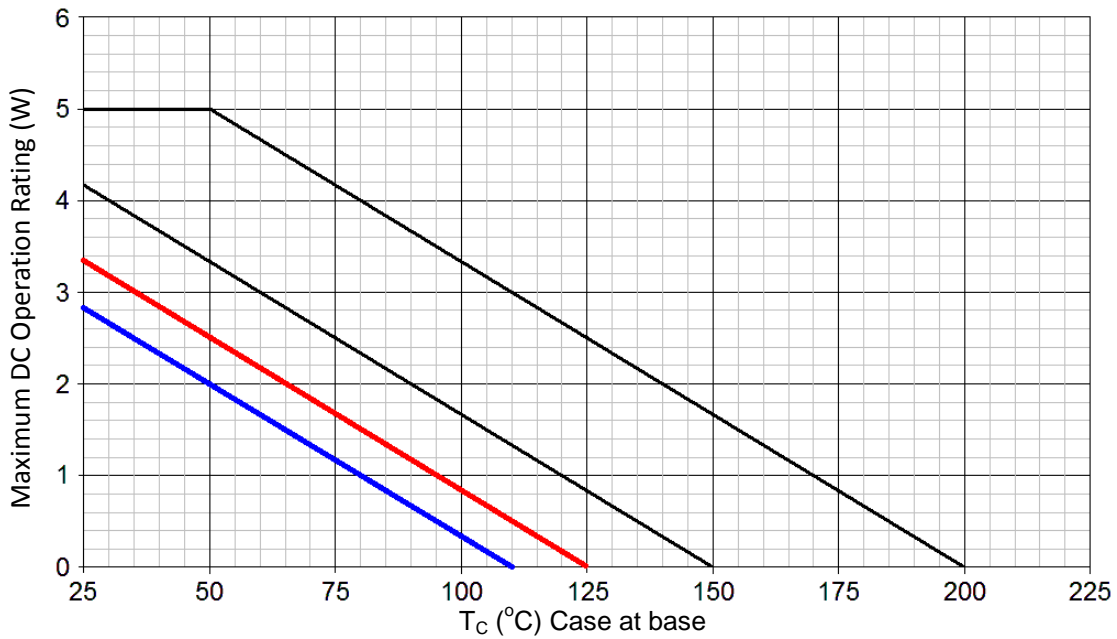
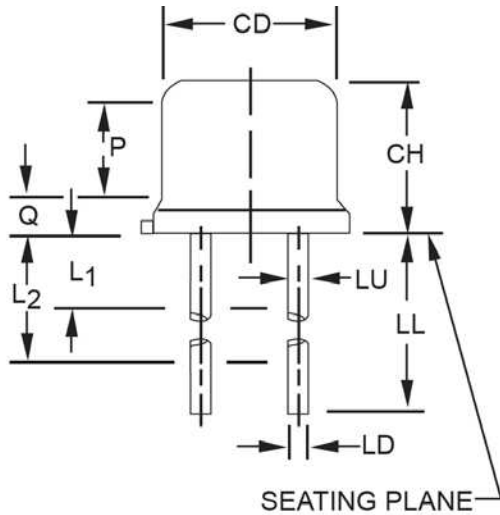
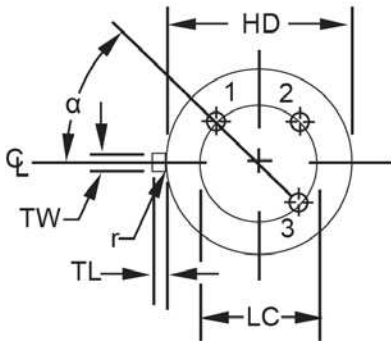


FIGURE 2
Temperature - Power Derating ($R_{\theta JC}$)

PACKAGE DIMENSIONS


| Symbol | Dimensions | | | | Notes |
|----------------|------------|------|-------------|-------|----------|
| | Inches | | Millimeters | | |
| | Min | Max | Min | Max | |
| CD | .305 | .335 | 7.75 | 8.51 | |
| CH | .240 | .260 | 6.10 | 6.60 | |
| HD | .335 | .370 | 8.51 | 9.40 | |
| LC | .200 TP | | 5.08 TP | | 6 |
| LD | .016 | .021 | 0.41 | 0.53 | 7, 8 |
| LL | .500 | .750 | 12.70 | 19.05 | 7, 8, 12 |
| LU | .016 | .019 | 0.41 | 0.48 | 7, 8 |
| L ₁ | | .050 | | 1.27 | 7, 8 |
| L ₂ | .250 | | 6.35 | | 7, 8 |
| Q | | .050 | | 1.27 | 5 |
| TL | .029 | .045 | 0.74 | 1.14 | 4 |
| TW | .028 | .034 | 0.71 | 0.86 | 3 |
| r | | .010 | | 0.25 | 10 |
| α | 45° TP | | 45° TP | | 6 |
| P | .100 | | 2.54 | | |


NOTES:

1. Dimension are in inches.
2. Millimeters are given for general information only.
3. Beyond r (radius) maximum, TW shall be held for a minimum length of .011 (0.28 mm).
4. Dimension TL measured from maximum HD.
5. Body contour optional within zone defined by HD, CD, and Q.
6. Leads at gauge plane .054 +.001 -.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within .007 inch (0.18 mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC. The device may be measured by direct methods.
7. Dimension LU applies between L₁ and L₂. Dimension LD applies between L₂ and minimum. Diameter is uncontrolled in L₁ and beyond LL minimum.
8. All three leads.
9. The collector shall be internally connected to the case.
10. Dimension r (radius) applies to both inside corners of tab.
11. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.
12. For "S" suffix devices, dimension LL is 0.500 (12.70 mm) minimum, 0.750 (19.05 mm) maximum.
13. Lead 1 = emitter, lead 2 = base, lead 3 = collector.
14. TO-39, Dim LL is 0.50" - 0.75"; TO-5, Dim LL is 1.500" - 1.750"